

STP30NM30N

N-channel 300V - 0.078Ω - 30A - TO-220 Ultra low gate charge MDmesh™ II Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)}	I _D
STP30NM30N	300V	<0.090Ω	30A

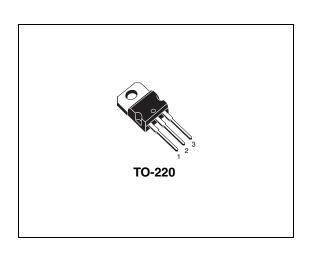
- Worldwide lowest gate charge
- High dv/dt avalanche capabilities
- Low input capacitance
- Low gate resistance

Description

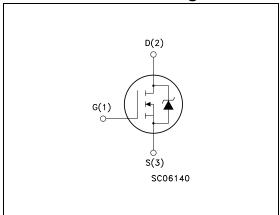
This 300V Power MOSFET with a new advanced layout brings all unique advantages of MDmesh™ technology to medium voltages. The device exhibits worldwide lowest gate charge for any given on-resistance. Its use is therefore ideal as primary side switch for DC-DC converters as well as for switch mode power supply allowing higher efficiencies and system miniaturization.

Application

Switching application



Internal schematic diagram



Order code

Part number	Marking	Package	Packaging	
STP30NM30N	P30NM30N	TO-220	Tube	

April 2007 Rev 1 1/12

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STP30NM30N Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	300	V
V_{GS}	Gate- source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25°C	30	Α
I _D	Drain current (continuous) at T _C = 100°C	18.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	120	Α
P _{TOT}	Total dissipation at T _C = 25°C	160	W
	Derating factor	1.28	W/°C
dv/dt	Peak diode recovery voltage slope	18	V/ns
T _j T _{stg}	Operating junction temperature Storage temperature	-65 to 150	°C

^{1.} $I_{SD} \le 30A$, di/dt $\le 400A/\mu s$, $V_{DD}=80\%V_{(BRDSS)}$

Table 2. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	0.78	°C/W
Rthj-amb	Thermal resistance junction-ambient max	62.5	°C/W

Table 3. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	15	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	900	mJ

Electrical characteristics STP30NM30N

2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1$ mA, $V_{GS} = 0$	300			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} = Max rating, T_{C} =125°C			1 100	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on}	Static drain-source on resistance	V _{GS} = 10V, I _D = 15A		0.075	0.090	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D = 15A		9		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50V$, f = 1 MHz, $V_{GS} = 0$		2500 500 70		pF pF pF
R _g	Gate input resistance	f=1MHz Gate DC Bias=0 Test signal level=20mV open drain		1.7		Ω
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 240V, I_{D} = 30A, V_{GS} = 10V (see Figure 13)		75 15 40		nC nC nC

^{1.} Pulsed: Pulse duration = $300 \mu s$, duty cycle 1.5%

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 150V, I _D = 15A,		25		ns
t _r	Rise time	$R_G = 4.7\Omega$, $V_{GS} = 10V$		25		ns
t _{d(off)}	Turn-off-delay time	(see Figure 12)		65		ns
t _f	Fall time	(666 / 19416 /2)		25		ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				30	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				120	Α
V _{SD} (2)	Forward on voltage	$I_{SD} = 30A, V_{GS} = 0$			1.3	V
t _{rr}	Reverse recovery time	$I_{SD} = 30A$, di/dt = 100A/ μ s		350		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 200V Tj = 25°C		5		μC
I _{RRM}	Reverse recovery current	(see Figure 17)		30		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300μ s, duty cycle 1.5%

Electrical characteristics STP30NM30N

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

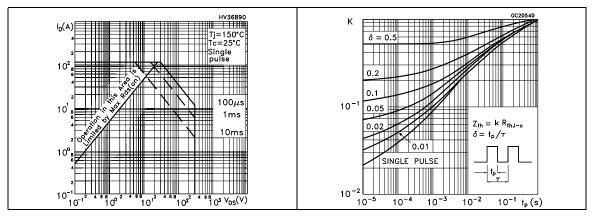


Figure 3. Output characteristics

Figure 4. Transfer characteristics

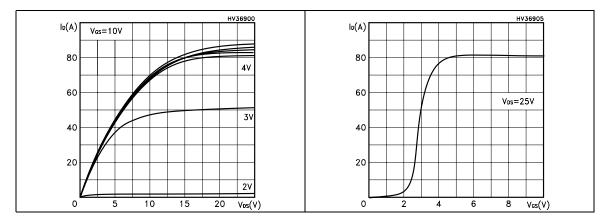


Figure 5. Normalized B_{VDSS} vs temperature

Figure 6. Static drain-source on resistance

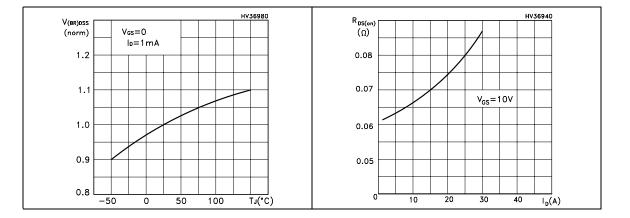


Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

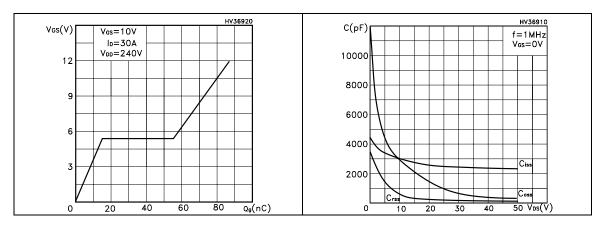


Figure 9. Normalized gate threshold voltage vs temperature

Figure 10. Normalized on resistance vs temperature

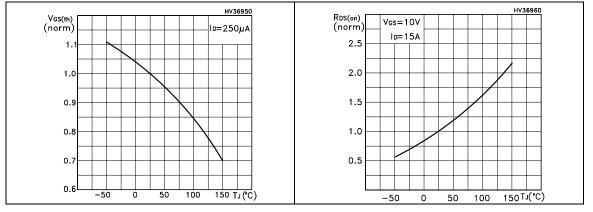
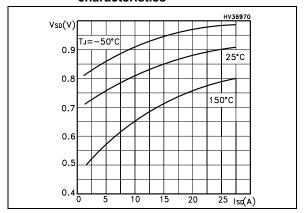


Figure 11. Source-drain diode forward characteristics



Test circuits STP30NM30N

3 Test circuits

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

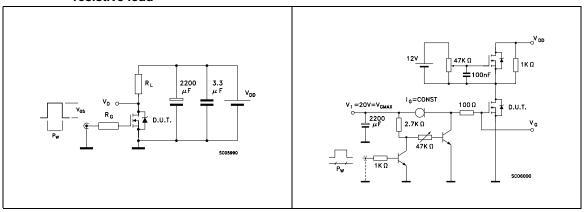


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped inductive load test circuit

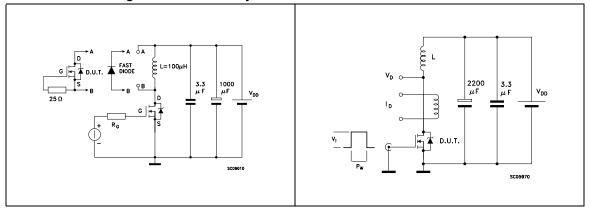
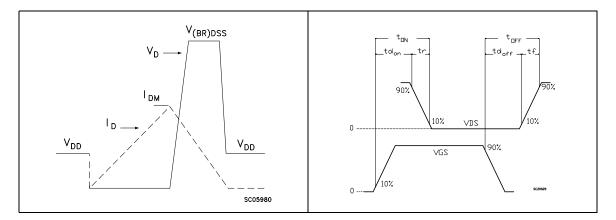


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



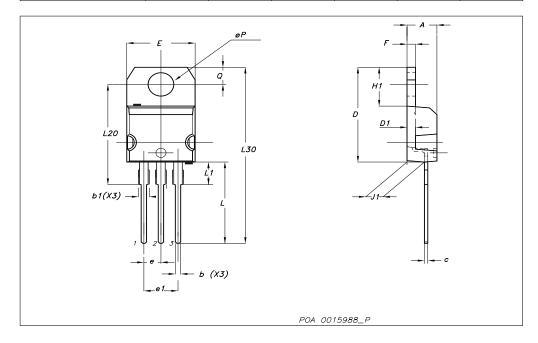
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-220 mechanical data

Dim		mm			inch		
Dim	Min	Тур	Max	Min	Тур	Max	
Α	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.14		1.70	0.044		0.066	
С	0.49		0.70	0.019		0.027	
D	15.25		15.75	0.6		0.62	
D1		1.27			0.050		
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.051	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137		
ØP	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



STP30NM30N Revision history

5 Revision history

Table 8. Revision history

Date	Revision	Changes
16-Apr-2007	1	First release

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